IXYS

Features:

- MX887P with 64 times faster sampling
- Omni polar (switches with N or S pole)
- 2.5 to 5.5 Volt Operation
- Simple Digital Output Interfacing CMOS Push-Pull
- Ultra Low Offset Canceling Amplifiers Provide Sensitive, Accurate, Stable Switching Points and Immunity to Mechanical Stress
- Solid State Circuitry
- Operating Temperature Range: -40°C to 100°C
- RoHS Compliant TSOT-23 3 Lead Package

Ordering Information

Part No.	Description	Qty
MX8871PHTTR	TSOT-23 3L Tape & Reel	3000

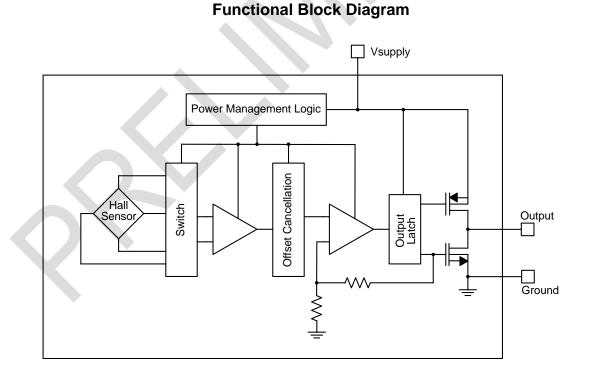
General Description

The MX8871P integrated Hall-Effect switch targets battery operating voltages from 2.5V to 5.5V. Onchip power management circuitry reduces the effective average current to just 125μ A at 3.0 VSUPPLY.

The switch output will transition to the Ground potential when either a north or south magnetic pole is applied. The absence of a magnetic field will transition the switch to the VSUPPLY potential.

Applications:

- White Goods
- Automotive
- Security Systems
- High Reliability Reed Switch Replacement



MX8871P Drawing No. 887109



Pin Description

Pin No.	Pin Name	Description
1	VSUPPLY	2.5 to 5.5 Volt
2	OUT	CMOS Push-Pull
3	GROUND	Ground

Circuit Description

The MX8871P Hall-Effect Switch consists of a Hall element, small signal amplifier, latch, and n-channel open drain MOSFET driver. Offset cancellation rejects errors in signal stages and the influence of mechanical stress on the Hall element. This technique together with a precision threshold generator and comparator produce highly accurate magnetic switch points. The Hall element is activated for a fraction of an operating cycle, then latched in that sample state for the remainder of the period. By using this technique, reduced power consumption is achieved.

Electrical Characteristics

Over operating voltage and temperature range unless otherwise noted.

Parameter	Condition	Min	Тур	Max	Unit
Supply Voltage		2.5		5.5	V
Output Leakage Current	VOUT = 5.5V, BRPN < B < BRPS		<1.0	1.0	μA
Output On Voltage	IOUT = 1mA, VDD = 3.0V		50	100	mV
Awake Time				80	μS
Period				1.2	mS
Duty Cycle			6		%
	Awake (enabled)			2.0	mA
Supply Current	Asleep (disabled)			8.0	μA
	Average (Calculated)		125		μA
ESD	Human Body Model	2			kV

Notes: 1. Operating and release points will vary with supply voltage.

2. BOPX = operating point (output turns ON); BRPX = release point (output turns OFF).

3. Typical Data is at TA = 25° C and VSUPPLY = 3.0V.

Magnetic Characteristics

Over operating voltage and temperature range unless otherwise noted.

Parameter	Symbol	Condition Min Typ				Unit
Operating Points	BOPS	South pole to branded side			60	G
Operating Points	BOPN	North pole to branded side	-60			G
Release Points	Brps	South pole to branded side	6			G
	Brpn	North pole to branded side			-6	G
Hysteresis	Bhys	Bopx – Brpx		5		G

Notes: 1. As use here, negative flux densities are defined as less than zero (algebraic convention) and -50G is less than +10G.

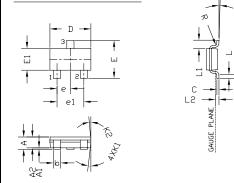
2. BOPX = operating point (output turns ON); BRPX = release point (output turns OFF).

3. Typical Data is at TA = 25° C and VSUPPLY = 3.0V.

MX8871P



TSOT23 - 3 LEAD



- 3. PACKAGE TOP MAY BE SMALLER THAN PACKAGE BOTTOM. DIMENSIONS D AND E1 ARE DETERMINED AT THE DUTERMOST EXTREME OF THE PLASTIC BODY EXCLUDING MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION 'E' DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSION SHALL NOT EXCEED .006' (0.15MM) PER SIDE.
- DIMENSION 'D' DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS AND GATE BURRS SHALL NOT EXCEED .004 IN. (0.10MM) PER SIDE.
- NOTES: (UNLESS OTHERWISE SPECIFIED)

DIMENSIONS							
DIM	INCH		MILLIMETER				
DIM.	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	
Α	0.030		0.035	0.75	-	0.90	
A1	0.000		0.004	0.00	-	0.10	
A2	0.028	0.030	0.031	0.70	0.75	0.80	
b	0.014		0.020	0.35		0.51	
С	0.004		0.010	0.10		0.25	
D	0.110	0.114	0.118	2.80	2.90	3.00	
E	0.102	0.110	0.118	2.60	2.80	3.00	
E1	0.059	0.063	0.067	1.50	1.60	1.70	
e	0.	0.0374 BSC			0.95 BSC		
e1	0.	0748 B	SC	1.90 BSC			
L	0.015	-		0.37	0.37		
L1	0.	0.0236 REF			0.60 REF		
L2	0.	0.0098 BSC			0.25 BSC		
У	_		0.004			0.10	
R	0.004	-		0.10			
К	0°	-	8°	0°		8°	
К1	7° N⊡M			7° N⊡M			
КS		5° NDM		5° N⊡M			

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IXYS

World Wide Sales Offices

IXYS Corporation

3540 Bassett Street Santa Clara, CA 925054 Tel: 1-408-982-0700 Fax: 1-408-496-0670 e-mail:sales@ixys.net

Micronix

An IXYS Company

145 Columbia Aliso Viejo, CA 92656-1490 Tel: 1-949-831-4622 Fax: 1-949-831-4628

SALES OFFICES AMERICAS

Eastern Region

[Eastern North America, Mexico, South America] IXYS Corporation Beverly, MA Tel: 508-528-6883 Fax: 508-528-4562 wgh@ixys.net

Central Region

[Central North America] IXYS Corporation Greensburg, PA Tel: 724-836-8530 Fax: 724-836-8540 neil.lejeune@westcode.com

Western Region

[Western North America] IXYS Corporation Solana Beach, CA Tel: 858-792-1101 slodor@ix.netcom.com

SALES OFFICES EUROPE

European Headquarters

IXYS Semiconductor GMBH Edisonstrasse 15 D- 68623 Lampertheim Germany Tel: 49-6206-503203 Fax: 49-6206-503286 marcom@ixys.de

United Kingdom

IXYS Semiconductor Limited Langley Park Way Langley Park Chippenham Wiltshire SN 15 1GE - England Tel: 44 1249 444524 Fax: 44 1249 659448 sales@ixys.co.uk

Sales Offices ASIA / PACIFIC

Asian Headquarters

IXYS Room 1016, Chia-Hsin, Bldg II, 10F, No. 96, Sec. 2 Chung Shan North Road Taipei, Taiwan R.O.C. Tel: 886-2-2523-6368 Fax: 886-2-2523-6368 bradley.green@ixys.co.uk Jhong@clare.com

Check the IXYS Website for the local sales office nearest you. (www.ixys.com)

http://www.claremicronix.com

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